PCN Number: 20170915003 PCN Date: Oct. 6, 2017   Title: Datasheet for TPS65283, TPS65283-1   Customer Contact: PCN Manager Dept: Quality Services   Proposed 1st Ship Date: Jan. 6, 2017   Change Type:   Assembly Site Design Wafer Bump Site   Assembly Process Data Sheet Wafer Bump Material   Assembly Materials Part number change Wafer Bump Process   Mechanical Specification Test Site Wafer Fab Site			
Customer Contact:       PCN Manager       Dept:       Quality Services         Proposed 1 <sup>st</sup> Ship Date:       Jan. 6, 2017         Change Type:       Design       Wafer Bump Site         Assembly Site       Data Sheet       Wafer Bump Material         Assembly Materials       Part number change       Wafer Bump Process			
Proposed 1st Ship Date:       Jan. 6, 2017         Change Type:       □ Design       □ Wafer Bump Site         □ Assembly Site       □ Design       □ Wafer Bump Material         □ Assembly Process       □ Data Sheet       □ Wafer Bump Material         □ Assembly Materials       □ Part number change       □ Wafer Bump Process			
Change Type:         ☐ Assembly Site       ☐ Design       ☐ Wafer Bump Site         ☐ Assembly Process       ☐ Data Sheet       ☐ Wafer Bump Material         ☐ Assembly Materials       ☐ Part number change       ☐ Wafer Bump Process			
☐ Assembly Site       ☐ Design       ☐ Wafer Bump Site         ☐ Assembly Process       ☐ Data Sheet       ☐ Wafer Bump Material         ☐ Assembly Materials       ☐ Part number change       ☐ Wafer Bump Process			
☐ Assembly Process       ☐ Data Sheet       ☐ Wafer Bump Material         ☐ Assembly Materials       ☐ Part number change       ☐ Wafer Bump Process			
Assembly Materials Part number change Wafer Bump Process			
The condition of the contraction in the contraction			
Packing/Shipping/Labeling Test Process Wafer Fab Materials			
Wafer Fab Process			
Notification Details			
Description of Change:			
The product datasheet(s) is being updated as summarized below. The following change history provides further details. The datasheet number will be changing.			
TEXAS INSTRUMENTS TPS65283, TPS65283-1 SLVSCL3D – JUNE 2014–REVISED AUGUST 2017			
Changes from Revision C (August 2014) to Revision D			
Changed Feature bullet from "from 100 mA to 2.7 A" to "up to 2.7 A"			
Deleted text "between typical 100 mA to about 2.7 A" in the 1st sentence of 2nd paragraph of Description			
• Changed "232 k $\Omega$ " to "80.6 k $\Omega$ " in the Description for RSET in the Pin Functions table			
• Added $I_{OS}$ spec condition for $R_{SET}$ = 80.6 k $\Omega$			
• Changed from "RSET is $9.1 \text{ k}\Omega \leq \text{RLIM} \leq 232 \text{ k}\Omega$ " to "RSET is $9.1 \text{ k}\Omega \leq \text{RLIM} \leq 80.6 \text{ k}\Omega$ " in the <i>Programming the Current-Limit Threshold</i> section.			
Changed from "adjustable 75 mA to 2.7 A" to "up to 2.7 mA" in the Comments section of Table 2 (4 places)			
The datasheet number will be changing.			
Device Family Change From: Change To:			
TPS65283, TPS65283-1 SLVSCL3C SLVSCL3D			
These changes may be reviewed at the datasheet links provided. http://www.ti.com/product/TPS65283			
Reason for Change:			
To more accurately reflect device characteristics.			
Anticipated impact on Fit, Form, Function, Quality or Reliability (positive / negative):			
Electrical specification performance changes as indicated above.			
Changes to product identification resulting from this PCN:			
None.			
None.			
None.  Product Affected:			

For questions regarding this notice, e-mails can be sent to the regional contacts shown below or your local Field Sales Representative.

Location	E-Mail
USA	PCNAmericasContact@list.ti.com
Europe	PCNEuropeContact@list.ti.com
Asia Pacific	PCNAsiaContact@list.ti.com
Japan	PCNJapanContact@list.ti.com